IN THE SPECIFICATION

Please amend paragraph [001] as follows:

[001]	This	patent	application	is	related	to	U.S.	Pater	nt Ap	plicat	ion	No.
<u>-/, 1</u>	0/772,971	entitled	"APPARA	TUS	S AND	N	METH	OD	FOR	MOI	DEL	ING
RELATIONSH	HIPS BETW	EEN SI	GNALS" [+	\tto:	rney Do	cke	t No.	I20 (6799	US]	filed	l on
[[]] <u>Febr</u>	uary 5, 2004	, which i	s incorporate	d b	y referen	ce.						